



Product Change Notification

113185 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 113185 - 00
Change Title: Intel® Server System R1304GL4DS9
PCN 113185-00, Product Design
Add a Mylar Bumper
Date of Publication: July 31, 2014

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material *:	Effective immediately
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** Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.*

Description of Change to the Customer:

Intel is implementing the following change on the Intel® Server System R1304GL4DS9:

Add a mylar bumper on the side of the optical drive bay to improve the fit of the optical drive mechanical assembly. See the image below:



Example of the mylar bumper on the side of the optical drive bay

Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers. Customers may need to validate the function and feature change once the post-change system is available.

This change was effective in June, 2014 and based on inventory levels customers will start seeing this change now.

Products Affected / Intel Ordering Codes:

ASMO SKU			
Product Code	MM#	Pre Change TA	Post Change TA
R1304GL4DS9	922790	G67854-003	G67854-004

PCN Revision History:

Date of Revision:

July 31, 2014

Revision Number:

00

Reason:

Originally Published PCN